



FLIP CHIP MODULES TEST SPECS

TYPE: W 100

EMITTER FOLLOWER

TEST	CONDITIONS	MAXIMUM	MINIMUM
UPPER LEVEL	$V_{IN} = 0.3V$	-400 MV	-200 MV
LOWER LEVEL	$V_{IN} = -3.2V$	-3.4 V	-2.9 V
V_{OC}	$V_{IN} = -8V$	-7.5 V	-5.5 V
UPPER LEVEL	$V_{IN} = 3.0$	-600 MV	-400 MV

TECHNICAL INFORMATION

Instruction literature and technical bulletins are available on all digital products, if you would like to be added to our mailing list for this type of material or if you have any questions about the equipment you have purchased, please contact the nearest Digital Sales Office.

MAINTENANCE INFORMATION

Repair of printed circuitry should be done with a low voltage, fairly cool soldering iron to prevent damage to the transistors and keep the copper from lifting. Oscilloscopes used to troubleshoot a module or system should be grounded to prevent damaging transients.

SEP 10 1965

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